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Understanding Embedded - DSP (Digital Signal Processors)

Embedded - DSP (Digital Signal Processors) are specialized microprocessors designed to perform complex mathematical computations on digital signals in real-time. Unlike general-purpose processors, DSPs are optimized for high-speed numeric processing tasks, making them ideal for applications that require efficient and precise manipulation of digital data. These processors are fundamental in converting and processing signals in various forms, including audio, video, and communication signals, ensuring that data is accurately interpreted and utilized in embedded systems.

Applications of Embedded - DSP (Digital Signal Processors)

Details	
Product Status	Active
Type	Fixed Point
Interface	Host Interface, Serial Port
Clock Rate	80MHz
Non-Volatile Memory	External
On-Chip RAM	256kB
Voltage - I/O	1.8V, 2.5V, 3.3V
Voltage - Core	1.90V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/adsp-2188nbstz-320

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REVISION HISTORY

8/06—Rev. 0 to Rev. A

Miscellaneous Format Updates..... Universal

Applied Corrections or Additional Information to:

The two address buses (PMA and DMA) share a single external address bus, allowing memory to be expanded off-chip, and the two data buses (PMD and DMD) share a single external data bus. Byte memory space and I/O memory space also share the external buses.

Program memory can store both instructions and data, permitting ADSP-218xN series members to fetch two operands in a single cycle, one from program memory and one from data memory. ADSP-218xN series members can fetch an operand from program memory and the next instruction in the same cycle.

In lieu of the address and data bus for external memory connection, ADSP-218xN series members may be configured for 16-bit Internal DMA port (IDMA port) connection to external systems. The IDMA port is made up of 16 data/address pins and five control pins. The IDMA port provides transparent, direct access to the DSP's on-chip program and data RAM.

An interface to low-cost byte-wide memory is provided by the Byte DMA port (BDMA port). The BDMA port is bidirectional and can directly address up to four megabytes of external RAM or ROM for off-chip storage of program overlays or data tables.

The byte memory and I/O memory space interface supports slow memories and I/O memory-mapped peripherals with programmable wait state generation. External devices can gain control of external buses with bus request/grant signals ($\overline{BR}$, $\overline{BGH}$, and $\overline{BG}$). One execution mode (Go Mode) allows the ADSP-218xN to continue running from on-chip memory. Normal execution mode requires the processor to halt while buses are granted.

ADSP-218xN series members can respond to eleven interrupts. There can be up to six external interrupts (one edge-sensitive, two level-sensitive, and three configurable) and seven internal interrupts generated by the timer, the serial ports (SPORT), the BDMA port, and the power-down circuitry. There is also a master $\overline{RESET}$ signal. The two serial ports provide a complete synchronous serial interface with optional companding in hardware and a wide variety of framed or frameless data transmit and receive modes of operation.

Each port can generate an internal programmable serial clock or accept an external serial clock.

ADSP-218xN series members provide up to 13 general-purpose flag pins. The data input and output pins on SPORT1 can be alternatively configured as an input flag and an output flag. In addition, eight flags are programmable as inputs or outputs, and three flags are always outputs.

A programmable interval timer generates periodic interrupts. A 16-bit count register (TCOUNT) decrements every n processor cycle, where n is a scaling value stored in an 8-bit register (TSCALE). When the value of the count register reaches zero, an interrupt is generated and the count register is reloaded from a 16-bit period register (TPERIOD).

Serial Ports

ADSP-218xN series members incorporate two complete synchronous serial ports (SPORT0 and SPORT1) for serial communications and multiprocessor communication.

Following is a brief list of the capabilities of the ADSP-218xN SPORTs. For additional information on Serial Ports, refer to the *ADSP-218x DSP Hardware Reference*.

- SPORTs are bidirectional and have a separate, double-buffered transmit and receive section.
- SPORTs can use an external serial clock or generate their own serial clock internally.
- SPORTs have independent framing for the receive and transmit sections. Sections run in a frameless mode or with frame synchronization signals internally or externally generated. Frame sync signals are active high or inverted, with either of two pulsewidths and timings.
- SPORTs support serial data word lengths from 3 bits to 16 bits and provide optional A-law and μ-law companding, according to CCITT recommendation G.711.
- SPORT receive and transmit sections can generate unique interrupts on completing a data word transfer.
- SPORTs can receive and transmit an entire circular buffer of data with only one overhead cycle per data word. An interrupt is generated after a data buffer transfer.
- SPORT0 has a multichannel interface to selectively receive and transmit a 24 word or 32-word, time-division multiplexed, serial bitstream.
- SPORT1 can be configured to have two external interrupts ($\overline{IRQ0}$ and $\overline{IRQ1}$) and the FI and FO signals. The internally generated serial clock may still be used in this configuration.

MODES OF OPERATION

The ADSP-218xN series modes of operation appear in Table 2.

Table 2. Modes of Operation

Mode D	Mode C	Mode B	Mode A	Booting Method
X	0	0	0	BDMA feature is used to load the first 32 program memory words from the byte memory space. Program execution is held off until all 32 words have been loaded. Chip is configured in Full Memory Mode.[1]
X	0	1	0	No automatic boot operations occur. Program execution starts at external memory location 0. Chip is configured in Full Memory Mode. BDMA can still be used, but the processor does not automatically use or wait for these operations.
0	1	0	0	BDMA feature is used to load the first 32 program memory words from the byte memory space. Program execution is held off until all 32 words have been loaded. Chip is configured in Host Mode. $\overline{\text{IACK}}$ has active pull-down. (Requires additonal hardware.)
0	1	0	1	IDMA feature is used to load any internal memory as desired. Program execution is held off until the host writes to internal program memory location 0. Chip is configured in Host Mode. $\overline{\text{IACK}}$ has active pull-down.[1]
1	1	0	0	BDMA feature is used to load the first 32 program memory words from the byte memory space. Program execution is held off until all 32 words have been loaded. Chip is configured in Host Mode; $\overline{\text{IACK}}$ requires external pull-down. (Requires additonal hardware.)
1	1	0	1	IDMA feature is used to load any internal memory as desired. Program execution is held off until the host writes to internal program memory location 0. Chip is configured in Host Mode. $\overline{\text{IACK}}$ requires external pull-down.[1]

[1] Considered as standard operating settings. Using these configurations allows for easier design and better memory management.

Setting Memory Mode

Memory Mode selection for the ADSP-218xN series is made during chip reset through the use of the Mode C pin. This pin is multiplexed with the DSP's PF2 pin, so care must be taken in how the mode selection is made. The two methods for selecting the value of Mode C are active and passive.

Passive Configuration

Passive Configuration involves the use of a pull-up or pull-down resistor connected to the Mode C pin. To minimize power consumption, or if the PF2 pin is to be used as an output in the DSP application, a weak pull-up or pull-down resistance, on the order of 10 kΩ, can be used. This value should be sufficient to pull the pin to the desired level and still allow the pin to operate as a programmable flag output without undue strain on the processor's output driver. For minimum power consumption during power-down, reconfigure PF2 to be an input, as the pull-up or pull-down resistance will hold the pin in a known state, and will not switch.

Active Configuration

Active Configuration involves the use of a three-statable external driver connected to the Mode C pin. A driver's output enable should be connected to the DSP's $\overline{\text{RESET}}$ signal such that it only drives the PF2 pin when $\overline{\text{RESET}}$ is active (low). When $\overline{\text{RESET}}$ is deasserted, the driver should be three-state, thus allowing full use of the PF2 pin as either an input or output. To minimize power consumption during power-down, configure the programmable flag as an output when connected to a three-stated buffer. This ensures that the pin will be held at a constant level, and will not oscillate should the three-state driver's level hover around the logic switching point.

IDMA ACK Configuration

Mode D = 0 and in host mode: $\overline{\text{IACK}}$ is an active, driven signal and cannot be "wire-OR'ed." Mode D = 1 and in host mode: $\overline{\text{IACK}}$ is an open drain and requires an external pull-down, but multiple $\overline{\text{IACK}}$ pins can be "wire-OR'ed" together.

INTERRUPTS

The interrupt controller allows the processor to respond to the eleven possible interrupts and reset with minimum overhead. ADSP-218xN series members provide four dedicated external interrupt input pins: $\overline{\text{IRQ2}}$, $\overline{\text{IRQL0}}$, $\overline{\text{IRQL1}}$, and $\overline{\text{IRQE}}$ (shared with the PF7–4 pins). In addition, SPORT1 may be reconfigured for $\overline{\text{IRQ0}}$, $\overline{\text{IRQ1}}$, FI, and FO, for a total of six external interrupts. The ADSP-218xN also supports internal interrupts from the timer, the byte DMA port, the two serial ports, software, and the power-down control circuit. The interrupt levels are internally prioritized and individually maskable (except power-down and reset). The $\overline{\text{IRQ2}}$, $\overline{\text{IRQ0}}$, and $\overline{\text{IRQ1}}$ input pins can be programmed to be either level- or edge-sensitive. $\overline{\text{IRQL0}}$ and $\overline{\text{IRQL1}}$ are level-sensitive and $\overline{\text{IRQE}}$ is edge-sensitive. The priorities and vector addresses of all interrupts are shown in Table 3.

Table 3. Interrupt Priority and Interrupt Vector Addresses

Source Of Interrupt	Interrupt Vector Address (Hex)
Reset (or Power-Up with PUCR = 1)	0x0000 (Highest Priority)
Power-Down (Nonmaskable)	0x002C
$\overline{\text{IRQ2}}$	0x0004
$\overline{\text{IRQL1}}$	0x0008
$\overline{\text{IRQL0}}$	0x000C
SPORT0 Transmit	0x0010
SPORT0 Receive	0x0014
$\overline{\text{IRQE}}$	0x0018
BDMA Interrupt	0x001C
SPORT1 Transmit or $\overline{\text{IRQ1}}$	0x0020
SPORT1 Receive or $\overline{\text{IRQ0}}$	0x0024
Timer	0x0028 (Lowest Priority)

Interrupt routines can either be nested with higher priority interrupts taking precedence or processed sequentially. Interrupts can be masked or unmasked with the IMASK register. Individual interrupt requests are logically ANDed with the bits in IMASK; the highest priority unmasked interrupt is then selected. The power-down interrupt is nonmaskable.

ADSP-218xN series members mask all interrupts for one instruction cycle following the execution of an instruction that modifies the IMASK register. This does not affect serial port autobuffering or DMA transfers.

The interrupt control register, ICNTL, controls interrupt nesting and defines the $\overline{\text{IRQ0}}$, $\overline{\text{IRQ1}}$, and $\overline{\text{IRQ2}}$ external interrupts to be either edge- or level-sensitive. The $\overline{\text{IRQE}}$ pin is an external edge-sensitive interrupt and can be forced and cleared. The $\overline{\text{IRQL0}}$ and $\overline{\text{IRQL1}}$ pins are external level sensitive interrupts.

The IFC register is a write-only register used to force and clear interrupts. On-chip stacks preserve the processor status and are automatically maintained during interrupt handling. The stacks are 12 levels deep to allow interrupt, loop, and subroutine nesting. The following instructions allow global enable or disable servicing of the interrupts (including power-down), regardless of the state of IMASK:

```
ENA INTS;
DIS INTS;
```

Disabling the interrupts does not affect serial port autobuffering or DMA. When the processor is reset, interrupt servicing is enabled.

LOW-POWER OPERATION

ADSP-218xN series members have three low-power modes that significantly reduce the power dissipation when the device operates under standby conditions. These modes are:

- Power-Down
- Idle
- Slow Idle

The CLKOUT pin may also be disabled to reduce external power dissipation.

Power-Down

ADSP-218xN series members have a low-power feature that lets the processor enter a very low-power dormant state through hardware or software control. Following is a brief list of power-down features. Refer to the *ADSP-218x DSP Hardware Reference*, "System Interface" chapter, for detailed information about the power-down feature.

- Quick recovery from power-down. The processor begins executing instructions in as few as 200 CLKIN cycles.
- Support for an externally generated TTL or CMOS processor clock. The external clock can continue running during power-down without affecting the lowest power rating and 200 CLKIN cycle recovery.
- Support for crystal operation includes disabling the oscillator to save power (the processor automatically waits approximately 4096 CLKIN cycles for the crystal oscillator to start or stabilize), and letting the oscillator run to allow 200 CLKIN cycle start-up.
- Power-down is initiated by either the power-down pin ($\overline{\text{PWD}}$) or the software power-down force bit. Interrupt support allows an unlimited number of instructions to be executed before optionally powering down. The power-down interrupt also can be used as a nonmaskable, edge-sensitive interrupt.
- Context clear/save control allows the processor to continue where it left off or start with a clean context when leaving the power-down state.
- The $\overline{\text{RESET}}$ pin also can be used to terminate power-down.
- Power-down acknowledge pin (PWDACK) indicates when the processor has entered power-down.

Idle

When the ADSP-218xN is in the Idle Mode, the processor waits indefinitely in a low-power state until an interrupt occurs. When an unmasked interrupt occurs, it is serviced; execution then continues with the instruction following the IDLE instruction. In Idle mode IDMA, BDMA, and autobuffer cycle steals still occur.

Slow Idle

The IDLE instruction is enhanced on ADSP-218xN series members to let the processor's internal clock signal be slowed, further reducing power consumption. The reduced clock frequency, a programmable fraction of the normal clock rate, is specified by a selectable divisor given in the IDLE instruction.

The format of the instruction is:

```
IDLE (n);
```

where n = 16, 32, 64, or 128. This instruction keeps the processor fully functional, but operating at the slower clock rate. While it is in this state, the processor's other internal clock signals,

Clock Signals

ADSP-218xN series members can be clocked by either a crystal or a TTL-compatible clock signal.

The CLKIN input cannot be halted, changed during operation, nor operated below the specified frequency during normal operation. The only exception is while the processor is in the power-down state. For additional information, refer to the *ADSP-218x DSP Hardware Reference*, for detailed information on this power-down feature.

If an external clock is used, it should be a TTL-compatible signal running at half the instruction rate. The signal is connected to the processor's CLKIN input. When an external clock is used, the XTAL pin must be left unconnected.

ADSP-218xN series members use an input clock with a frequency equal to half the instruction rate; a 40 MHz input clock yields a 12.5 ns processor cycle (which is equivalent to 80 MHz). Normally, instructions are executed in a single processor cycle. All device timing is relative to the internal instruction clock rate, which is indicated by the CLKOUT signal when enabled.

Because ADSP-218xN series members include an on-chip oscillator circuit, an external crystal may be used. The crystal should be connected across the CLKIN and XTAL pins, with two capacitors connected as shown in Figure 3. Capacitor values are dependent on crystal type and should be specified by the crystal manufacturer. A parallel-resonant, fundamental frequency, microprocessor-grade crystal should be used. To provide an adequate feedback path around the internal amplifier circuit, place a resistor in parallel with the circuit, as shown in Figure 3.

A clock output (CLKOUT) signal is generated by the processor at the processor's cycle rate. This can be enabled and disabled by the CLKODIS bit in the SPORT0 Autobuffer Control Register.

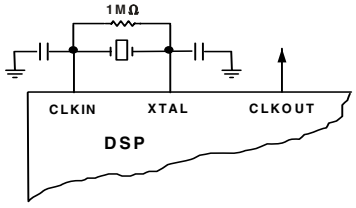

Figure 3. External Crystal Connections

RESET

The $\overline{\text{RESET}}$ signal initiates a master reset of the ADSP-218xN. The $\overline{\text{RESET}}$ signal must be asserted during the power-up sequence to assure proper initialization. $\overline{\text{RESET}}$ during initial power-up must be held long enough to allow the internal clock to stabilize. If $\overline{\text{RESET}}$ is activated any time after power-up, the clock continues to run and does not require stabilization time.

The power-up sequence is defined as the total time required for the crystal oscillator circuit to stabilize after a valid V_{DD} is applied to the processor, and for the internal phase-locked loop (PLL) to lock onto the specific crystal frequency. A minimum of 2000 CLKIN cycles ensures that the PLL has locked, but does not include the crystal oscillator start-up time. During this power-up sequence the $\overline{\text{RESET}}$ signal should be held low. On any subsequent resets, the $\overline{\text{RESET}}$ signal must meet the minimum pulse-width specification (t_{RSP}).

The $\overline{\text{RESET}}$ input contains some hysteresis; however, if an RC circuit is used to generate the $\overline{\text{RESET}}$ signal, the use of an external Schmitt trigger is recommended.

The master reset sets all internal stack pointers to the empty stack condition, masks all interrupts, and clears the MSTAT register. When $\overline{\text{RESET}}$ is released, if there is no pending bus request and the chip is configured for booting, the boot-loading sequence is performed. The first instruction is fetched from on-chip program memory location 0x0000 once boot loading completes.

POWER SUPPLIES

ADSP-218xN series members have separate power supply connections for the internal (V_{DDINT}) and external (V_{DDEXT}) power supplies. The internal supply must meet the 1.8 V requirement. The external supply can be connected to a 1.8 V, 2.5 V, or 3.3 V supply. All external supply pins must be connected to the same supply. All input and I/O pins can tolerate input voltages up to 3.6 V, regardless of the external supply voltage. This feature provides maximum flexibility in mixing 1.8 V, 2.5 V, or 3.3 V components.

MEMORY ARCHITECTURE

The ADSP-218xN series provides a variety of memory and peripheral interface options. The key functional groups are Program Memory, Data Memory, Byte Memory, and I/O. Refer to Figure 4 through Figure 9, Table 4 on Page 11, and Table 5 on Page 11 for PM and DM memory allocations in the ADSP-218xN series.

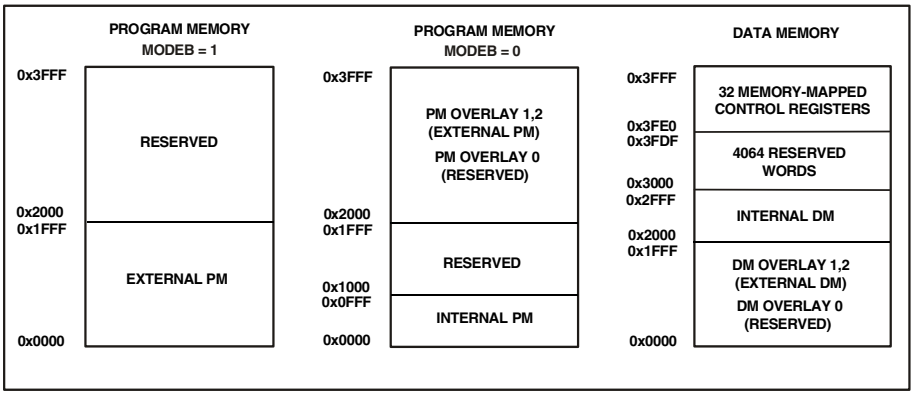

Figure 4. ADSP-2184 Memory Architecture

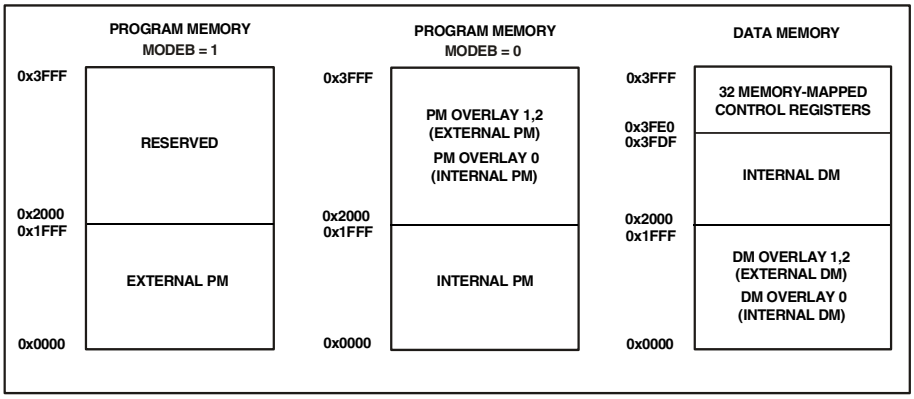

Figure 5. ADSP-2185 Memory Architecture

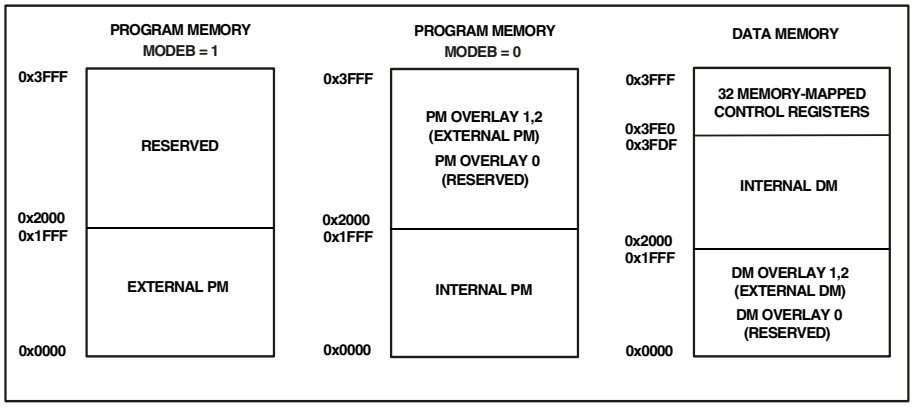

Figure 6. ADSP-2186 Memory Architecture

IOWAIT0–3 as shown in Figure 10, which in combination with the wait state mode bit, specify up to 15 wait states to be automatically generated for each of four regions. The wait states act on address ranges, as shown in Table 6.

Note: In Full Memory Mode, all 2048 locations of I/O space are directly addressable. In Host Memory Mode, only address pin A0 is available; therefore, additional logic is required externally to achieve complete addressability of the 2048 I/O space locations.

Table 6. Wait States

Address Range	Wait State Register
0x000–0x1FF	IOWAIT0 and Wait State Mode Select Bit
0x200–0x3FF	IOWAIT1 and Wait State Mode Select Bit
0x400–0x5FF	IOWAIT2 and Wait State Mode Select Bit
0x600–0x7FF	IOWAIT3 and Wait State Mode Select Bit

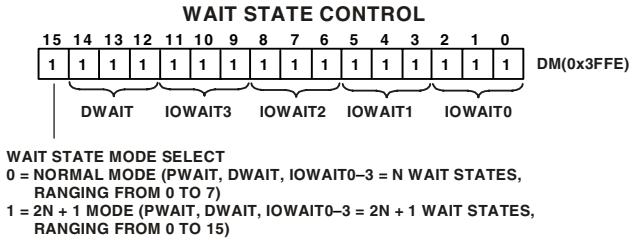

Figure 10. Wait State Control Register

Composite Memory Select

ADSP-218xN series members have a programmable memory select signal that is useful for generating memory select signals for memories mapped to more than one space. The $\overline{\text{CMS}}$ signal is generated to have the same timing as each of the individual memory select signals ($\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$) but can combine their functionality. Each bit in the CMSSEL register, when set, causes the $\overline{\text{CMS}}$ signal to be asserted when the selected memory select is asserted. For example, to use a 32K word memory to act as both program and data memory, set the $\overline{\text{PMS}}$ and $\overline{\text{DMS}}$ bits in the CMSSEL register and use the $\overline{\text{CMS}}$ pin to drive the chip select of the memory, and use either $\overline{\text{DMS}}$ or $\overline{\text{PMS}}$ as the additional address bit.

The $\overline{\text{CMS}}$ pin functions like the other memory select signals with the same timing and bus request logic. A 1 in the enable bit causes the assertion of the $\overline{\text{CMS}}$ signal at the same time as the selected memory select signal. All enable bits default to 1 at reset, except the $\overline{\text{BMS}}$ bit.

See Figure 11 and Figure 12 for illustration of the programmable flag and composite control register and the system control register.

Byte Memory Select

The ADSP-218xN's $\overline{\text{BMS}}$ disable feature combined with the $\overline{\text{CMS}}$ pin allows use of multiple memories in the byte memory space. For example, an EPROM could be attached to the $\overline{\text{BMS}}$

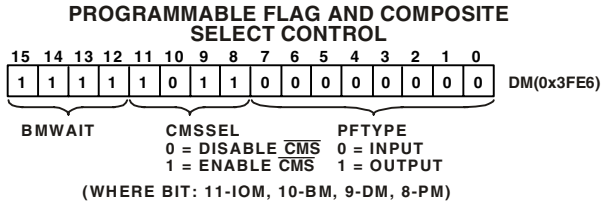

Figure 11. Programmable Flag and Composite Control Register

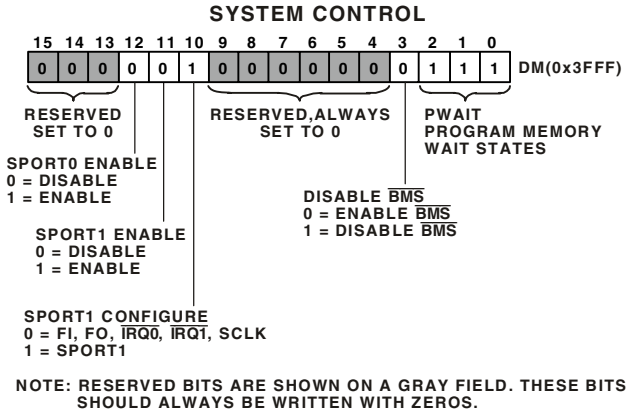

Figure 12. System Control Register

select, and a flash memory could be connected to $\overline{\text{CMS}}$. Because at reset $\overline{\text{BMS}}$ is enabled, the EPROM would be used for booting. After booting, software could disable $\overline{\text{BMS}}$ and set the $\overline{\text{CMS}}$ signal to respond to $\overline{\text{BMS}}$, enabling the flash memory.

Byte Memory

The byte memory space is a bidirectional, 8-bit-wide, external memory space used to store programs and data. Byte memory is accessed using the BDMA feature. The byte memory space consists of 256 pages, each of which is 16K × 8 bits.

The byte memory space on the ADSP-218xN series supports read and write operations as well as four different data formats. The byte memory uses data bits 15–8 for data. The byte memory uses data bits 23–16 and address bits 13–0 to create a 22-bit address. This allows up to a 4 megabit × 8 (32 megabit) ROM or RAM to be used without glue logic. All byte memory accesses are timed by the BMWAIT register and the wait state mode bit.

Byte Memory DMA (BDMA, Full Memory Mode)

The byte memory DMA controller (Figure 13) allows loading and storing of program instructions and data using the byte memory space. The BDMA circuit is able to access the byte memory space while the processor is operating normally and steals only one DSP cycle per 8-, 16-, or 24-bit word transferred.

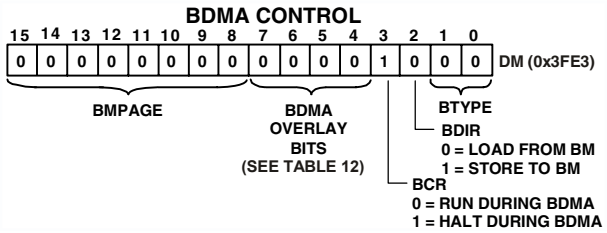

Figure 13. BDMA Control Register

The BDMA circuit supports four different data formats that are selected by the BTYPE register field. The appropriate number of 8-bit accesses are done from the byte memory space to build the word size selected. Table 7 shows the data formats supported by the BDMA circuit.

Table 7. Data Formats

BTYPE	Internal Memory Space	Word Size	Alignment
00	Program Memory	24	Full Word
01	Data Memory	16	Full Word
10	Data Memory	8	MSBs
11	Data Memory	8	LSBs

Unused bits in the 8-bit data memory formats are filled with 0s. The BIAD register field is used to specify the starting address for the on-chip memory involved with the transfer. The 14-bit BEAD register specifies the starting address for the external byte memory space. The 8-bit BMPAGE register specifies the starting page for the external byte memory space. The BDIR register field selects the direction of the transfer. Finally, the 14-bit BWCOUNT register specifies the number of DSP words to transfer and initiates the BDMA circuit transfers.

BDMA accesses can cross page boundaries during sequential addressing. A BDMA interrupt is generated on the completion of the number of transfers specified by the BWCOUNT register.

The BWCOUNT register is updated after each transfer so it can be used to check the status of the transfers. When it reaches zero, the transfers have finished and a BDMA interrupt is generated. The BMPAGE and BEAD registers must not be accessed by the DSP during BDMA operations.

The source or destination of a BDMA transfer will always be on-chip program or data memory.

When the BWCOUNT register is written with a nonzero value the BDMA circuit starts executing byte memory accesses with wait states set by BMWAIT. These accesses continue until the count reaches zero. When enough accesses have occurred to create a destination word, it is transferred to or from on-chip memory. The transfer takes one DSP cycle. DSP accesses to external memory have priority over BDMA byte memory accesses.

The BDMA Context Reset bit (BCR) controls whether the processor is held off while the BDMA accesses are occurring. Setting the BCR bit to 0 allows the processor to continue operations. Setting the BCR bit to 1 causes the processor to stop execution while the BDMA accesses are occurring, to clear the context of the processor, and start execution at address 0 when the BDMA accesses have completed.

The BDMA overlay bits specify the OVLAY memory blocks to be accessed for internal memory. Set these bits as indicated in Figure 13.

Note: BDMA cannot access external overlay memory regions 1 and 2.

The BMWAIT field, which has four bits on ADSP-218xN series members, allows selection up to 15 wait states for BDMA transfers.

Internal Memory DMA Port (IDMA Port; Host Memory Mode)

The IDMA Port provides an efficient means of communication between a host system and ADSP-218xN series members. The port is used to access the on-chip program memory and data memory of the DSP with only one DSP cycle per word overhead. The IDMA port cannot, however, be used to write to the DSP's memory-mapped control registers. A typical IDMA transfer process is shown as follows:

1. Host starts IDMA transfer.
2. Host checks $\overline{\text{IACK}}$ control line to see if the DSP is busy.
3. Host uses $\overline{\text{IS}}$ and IAL control lines to latch either the DMA starting address (IDMAA) or the PM/DM OVLAY selection into the DSP's IDMA control registers. If Bit 15 = 1, the values of Bits 7–0 represent the IDMA overlay; Bits 14–8 must be set to 0. If Bit 15 = 0, the value of Bits 13–0 represent the starting address of internal memory to be accessed and Bit 14 reflects PM or DM for access. Set IDDMOVLAY and IDPMOVLAY bits in the IDMA overlay register as indicted in Table 8.
4. Host uses $\overline{\text{IS}}$ and $\overline{\text{IRD}}$ (or $\overline{\text{IWR}}$) to read (or write) DSP internal memory (PM or DM).
5. Host checks $\overline{\text{IACK}}$ line to see if the DSP has completed the previous IDMA operation.
6. Host ends IDMA transfer.

Table 8. IDMA/BDMA Overlay Bits

Processor	IDMA/BDMA PMOVLAY	IDMA/BDMA DMOVLAY
ADSP-2184N	0	0
ADSP-2185N	0	0
ADSP-2186N	0	0
ADSP-2187N	0, 4, 5	0, 4, 5
ADSP-2188N	0, 4, 5, 6, 7	0, 4, 5, 6, 7, 8
ADSP-2189N	0, 4, 5	0, 4, 5, 6, 7

The IDMA port has a 16-bit multiplexed address and data bus and supports 24-bit program memory. The IDMA port is completely asynchronous and can be written while the ADSP-218xN is operating at full speed.

The DSP memory address is latched and then automatically incremented after each IDMA transaction. An external device can therefore access a block of sequentially addressed memory by specifying only the starting address of the block. This increases throughput as the address does not have to be sent for each memory access.

IDMA port access occurs in two phases. The first is the IDMA Address Latch cycle. When the acknowledge is asserted, a 14-bit address and 1-bit destination type can be driven onto the bus by an external device. The address specifies an on-chip memory location, the destination type specifies whether it is a DM or PM access. The falling edge of the IDMA address latch signal (IAL) or the missing edge of the IDMA select signal ($\overline{IS}$) latches this value into the IDMAA register.

Once the address is stored, data can be read from, or written to, the ADSP-218xN's on-chip memory. Asserting the select line ($\overline{IS}$) and the appropriate read or write line ($\overline{IRD}$ and $\overline{IWR}$ respectively) signals the ADSP-218xN that a particular transaction is required. In either case, there is a one-processor-cycle delay for synchronization. The memory access consumes one additional processor cycle.

Once an access has occurred, the latched address is automatically incremented, and another access can occur.

Through the IDMAA register, the DSP can also specify the starting address and data format for DMA operation. Asserting the IDMA port select ($\overline{IS}$) and address latch enable (IAL) directs the ADSP-218xN to write the address onto the IAD14–0 bus into the IDMA Control Register (Figure 14). If Bit 15 is set to 0, IDMA latches the address. If Bit 15 is set to 1, IDMA latches into the OVLAY register. This register, also shown in Figure 14, is memory-mapped at address DM (0x3FE0). Note that the latched address (IDMAA) cannot be read back by the host.

When Bit 14 in 0x3FE7 is set to zero, short reads use the timing shown in Figure 36 on Page 38. When Bit 14 in 0x3FE7 is set to 1, timing in Figure 37 on Page 39 applies for short reads in short read only mode. Set IDDMOVLAY and IDPMOVLAY bits in the IDMA overlay register as indicated in Table 8. Refer to the *ADSP-218x DSP Hardware Reference* for additional details.

Note: In full memory mode all locations of 4M-byte memory space are directly addressable. In host memory mode, only address pin A0 is available, requiring additional external logic to provide address information for the byte.

Bootstrap Loading (Booting)

ADSP-218xN series members have two mechanisms to allow automatic loading of the internal program memory after reset. The method for booting is controlled by the Mode A, B, and C configuration bits.

When the mode pins specify BDMA booting, the ADSP-218xN initiates a BDMA boot sequence when reset is released.

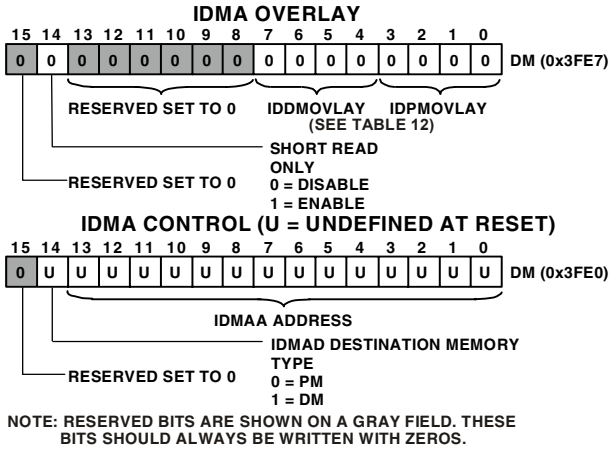

Figure 14. IDMA OVLAY/Control Registers

The BDMA interface is set up during reset to the following defaults when BDMA booting is specified: the BDIR, BMPAGE, BIAD, and BEAD registers are set to 0, the BTYPE register is set to 0 to specify program memory 24-bit words, and the BWCOUNT register is set to 32. This causes 32 words of on-chip program memory to be loaded from byte memory. These 32 words are used to set up the BDMA to load in the remaining program code. The BCR bit is also set to 1, which causes program execution to be held off until all 32 words are loaded into on-chip program memory. Execution then begins at address 0.

The ADSP-2100 Family development software (Revision 5.02 and later) fully supports the BDMA booting feature and can generate byte memory space-compatible boot code.

The IDLE instruction can also be used to allow the processor to hold off execution while booting continues through the BDMA interface. For BDMA accesses while in Host Mode, the addresses to boot memory must be constructed externally to the ADSP-218xN. The only memory address bit provided by the processor is A0.

IDMA Port Booting

ADSP-218xN series members can also boot programs through its internal DMA port. If Mode C = 1, Mode B = 0, and Mode A = 1, the ADSP-218xN boots from the IDMA port. IDMA feature can load as much on-chip memory as desired. Program execution is held off until the host writes to on-chip program memory location 0.

BUS REQUEST AND BUS GRANT

ADSP-218xN series members can relinquish control of the data and address buses to an external device. When the external device requires access to memory, it asserts the Bus Request

($\overline{BR}$) signal. If the ADSP-218xN is not performing an external memory access, it responds to the active $\overline{BR}$ input in the following processor cycle by:

- Three-stating the data and address buses and the $\overline{PMS}$, $\overline{DMS}$, $\overline{BMS}$, $\overline{CMS}$, $\overline{IOMS}$, $\overline{RD}$, $\overline{WR}$ output drivers,
- Asserting the bus grant ($\overline{BG}$) signal, and
- Halting program execution.

If Go Mode is enabled, the ADSP-218xN will not halt program execution until it encounters an instruction that requires an external memory access.

If an ADSP-218xN series member is performing an external memory access when the external device asserts the $\overline{BR}$ signal, it will not three-state the memory interfaces nor assert the $\overline{BG}$ signal until the processor cycle after the access completes. The instruction does not need to be completed when the bus is granted. If a single instruction requires two external memory accesses, the bus will be granted between the two accesses.

When the $\overline{BR}$ signal is released, the processor releases the $\overline{BG}$ signal, re-enables the output drivers, and continues program execution from the point at which it stopped.

The bus request feature operates at all times, including when the processor is booting and when $\overline{RESET}$ is active.

The $\overline{BGH}$ pin is asserted when an ADSP-218xN series member requires the external bus for a memory or BDMA access, but is stopped. The other device can release the bus by deasserting bus request. Once the bus is released, the ADSP-218xN deasserts $\overline{BG}$ and $\overline{BGH}$ and executes the external memory access.

FLAG I/O PINS

ADSP-218xN series members have eight general-purpose programmable input/output flag pins. They are controlled by two memory-mapped registers. The PFTYPE register determines the direction, 1 = output and 0 = input. The PFDATA register is used to read and write the values on the pins. Data being read from a pin configured as an input is synchronized to the ADSP-218xN's clock. Bits that are programmed as outputs will read the value being output. The PF pins default to input during reset.

In addition to the programmable flags, ADSP-218xN series members have five fixed-mode flags, FI, FO, FL0, FL1, and FL2. FL0 to FL2 are dedicated output flags. FI and FO are available as an alternate configuration of SPORT1.

Note: Pins PF0, PF1, PF2, and PF3 are also used for device configuration during reset.

INSTRUCTION SET DESCRIPTION

The ADSP-218xN series assembly language instruction set has an algebraic syntax that was designed for ease of coding and readability. The assembly language, which takes full advantage of the processor's unique architecture, offers the following benefits:

- The algebraic syntax eliminates the need to remember cryptic assembler mnemonics. For example, a typical arithmetic add instruction, such as AR = AX0 + AY0, resembles a simple equation.
- Every instruction assembles into a single, 24-bit word that can execute in a single instruction cycle.
- The syntax is a superset ADSP-2100 Family assembly language and is completely source and object code compatible with other family members. Programs may need to be relocated to utilize on-chip memory and conform to the ADSP-218xN's interrupt vector and reset vector map.
- Sixteen condition codes are available. For conditional jump, call, return, or arithmetic instructions, the condition can be checked and the operation executed in the same instruction cycle.
- Multifunction instructions allow parallel execution of an arithmetic instruction, with up to two fetches or one write to processor memory space, during a single instruction cycle.

DEVELOPMENT SYSTEM

Analog Devices' wide range of software and hardware development tools supports the ADSP-218xN series. The DSP tools include an integrated development environment, an evaluation kit, and a serial port emulator.

VisualDSP++®† is an integrated development environment, allowing for fast and easy development, debug, and deployment. The VisualDSP++ project management environment lets programmers develop and debug an application. This environment includes an easy-to-use assembler that is based on an algebraic syntax; an archiver (librarian/library builder); a linker; a PROM-splitter utility; a cycle-accurate, instruction-level simulator; a C compiler; and a C run-time library that includes DSP and mathematical functions.

Debugging both C and assembly programs with the VisualDSP++ debugger, programmers can:

- View mixed C and assembly code (interleaved source and object information)
- Insert break points
- Set conditional breakpoints on registers, memory, and stacks
- Trace instruction execution

† VisualDSP++ is a registered trademark of Analog Devices, Inc.

PIN DESCRIPTIONS

ADSP-218xN series members are available in a 100-lead LQFP package and a 144-ball BGA package. In order to maintain maximum functionality and reduce package size and pin count, some serial port, programmable flag, interrupt and external bus pins have dual, multiplexed functionality. The external bus pins are configured during $\overline{\text{RESET}}$ only, while serial port pins are software configurable during program execution. Flag and interrupt functionality is retained concurrently on multiplexed pins. In cases where pin functionality is reconfigurable, the default state is shown in plain text in Table 9, while alternate functionality is shown in *italics*.

Table 9. Common-Mode Pins

Pin Name	No. of Pins	I/O	Function
$\overline{\text{RESET}}$	1	I	Processor Reset Input
$\overline{\text{BR}}$	1	I	Bus Request Input
$\overline{\text{BG}}$	1	O	Bus Grant Output
$\overline{\text{BGH}}$	1	O	Bus Grant Hung Output
$\overline{\text{DMS}}$	1	O	Data Memory Select Output
$\overline{\text{PMS}}$	1	O	Program Memory Select Output
$\overline{\text{IOMS}}$	1	O	Memory Select Output
$\overline{\text{BMS}}$	1	O	Byte Memory Select Output
$\overline{\text{CMS}}$	1	O	Combined Memory Select Output
$\overline{\text{RD}}$	1	O	Memory Read Enable Output
$\overline{\text{WR}}$	1	O	Memory Write Enable Output
$\overline{\text{IRQ2}}$	1	I	Edge- or Level-Sensitive Interrupt Request[1]
PF7		I/O	Programmable I/O Pin
$\overline{\text{IRQL1}}$	1	I	Level-Sensitive Interrupt Requests[1]
PF6		I/O	Programmable I/O Pin
$\overline{\text{IRQL0}}$	1	I	Level-Sensitive Interrupt Requests[1]
PF5		I/O	Programmable I/O Pin
$\overline{\text{IRQE}}$	1	I	Edge-Sensitive Interrupt Requests[1]
PF4		I/O	Programmable I/O Pin
Mode D	1	I	Mode Select Input—Checked Only During $\overline{\text{RESET}}$
PF3		I/O	Programmable I/O Pin During Normal Operation
Mode C	1	I	Mode Select Input—Checked Only During $\overline{\text{RESET}}$
PF2		I/O	Programmable I/O Pin During Normal Operation
Mode B	1	I	Mode Select Input—Checked Only During $\overline{\text{RESET}}$
PF1		I/O	Programmable I/O Pin During Normal Operation
Mode A	1	I	Mode Select Input—Checked Only During $\overline{\text{RESET}}$
PF0		I/O	Programmable I/O Pin During Normal Operation
CLKIN	1	I	Clock Input
XTAL	1	O	Quartz Crystal Output
CLKOUT	1	O	Processor Clock Output
SPORT0	5	I/O	Serial Port I/O Pins
SPORT1	5	I/O	Serial Port I/O Pins
$\overline{\text{IRQ1–0}}$, FI, FO			Edge- or Level-Sensitive Interrupts, FI, FO[2]
$\overline{\text{PWD}}$	1	I	Power-Down Control Input
PWDACK	1	O	Power-Down Acknowledge Control Output
FL0, FL1, FL2	3	O	Output Flags
V_{DDINT}	2	I	Internal V_{DD} (1.8 V) Power (LQFP)
V_{DDEXT}	4	I	External V_{DD} (1.8 V, 2.5 V, or 3.3 V) Power (LQFP)
GND	10	I	Ground (LQFP)

Parameter[1]	Description	Test Conditions	Min	Typ	Max	Unit
I_{DD}	Supply Current (Idle)[9]	@ V_{DDINT} = 1.9 V, t_{CK} = 12.5 ns, T_{AMB} = 25°C		6.5		mA
I_{DD}	Supply Current (Dynamic)[10]	@ V_{DDINT} = 1.9 V, t_{CK} = 12.5 ns[11], T_{AMB} = 25°C		26		mA
I_{DD}	Supply Current (Power-Down)[12]	@ V_{DDINT} = 1.8 V, T_{AMB} = 25°C in Lowest Power Mode		100		µA
C_I	Input Pin Capacitance[3, 6]	@ V_{IN} = 1.8 V, f_{IN} = 1.0 MHz, T_{AMB} = 25°C			8	pF
C_O	Output Pin Capacitance[6, 7, 12, 13]	@ V_{IN} = 1.8 V, f_{IN} = 1.0 MHz, T_{AMB} = 25°C			8	pF

[1] Specifications subject to change without notice.
[2] Bidirectional pins: D23–0, RFS0, RFS1, SCLK0, SCLK1, TFS0, TFS1, A13–1, PF7–0.
[3] Input only pins: CLKIN, $\overline{\text{RESET}}$, $\overline{\text{BR}}$, DR0, DR1, $\overline{\text{PWD}}$.
[4] Output pins: $\overline{\text{BG}}$, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$, $\overline{\text{CMS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, PWDACK, A0, DT0, DT1, CLKOUT, FL2–FL0, $\overline{\text{BGH}}$.
[5] Although specified for TTL outputs, all ADSP-218xN outputs are CMOS-compatible and will drive to V_{DDEXT} and GND, assuming no dc loads.
[6] Guaranteed but not tested.
[7] Three-statable pins: A13–A1, D23–D0, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$, $\overline{\text{CMS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, DT0, DT1, SCLK0, SCLK1, TFS0, TFS1, RFS0, RFS1, PF7–PF0.
[8] 0 V on $\overline{\text{BR}}$.
[9] Idle refers to ADSP-218xN state of operation during execution of IDLE instruction. Deasserted pins are driven to either V_{DD} or GND.
[10] I_{DD} measurement taken with all instructions executing from internal memory. 50% of the instructions are multifunction (Types 1, 4, 5, 12, 13, 14), 30% are Type 2 and Type 6, and 20% are idle instructions.
[11] V_{IN} = 0 V and 3 V. For typical values for supply currents, refer to *Power Dissipation* section.
[12] See *ADSP-218x DSP Hardware Reference* for details.
[13] Output pin capacitance is the capacitive load for any three-stated output pin.

ABSOLUTE MAXIMUM RATINGS

Parameter	Rating
Internal Supply Voltage (V_{DDINT})[1]	–0.3 V to +2.2 V
External Supply Voltage (V_{DDEXT})	–0.3 V to +4.0 V
Input Voltage[2]	–0.5 V to +4.0 V
Output Voltage Swing[3]	–0.5 V to V_{DDEXT} +0.5 V
Operating Temperature Range	–40°C to +85°C
Storage Temperature Range	–65°C to +150°C

[1] Stresses greater than those listed above may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
[2] Applies to Bidirectional pins (D23–0, RFS0, RFS1, SCLK0, SCLK1, TFS0, TFS1, A13–1, PF7–0) and Input only pins (CLKIN, $\overline{\text{RESET}}$, $\overline{\text{BR}}$, DR0, DR1, $\overline{\text{PWD}}$).
[3] Applies to Output pins ($\overline{\text{BG}}$, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$, $\overline{\text{CMS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, PWDACK, A0, DT0, DT1, CLKOUT, FL2–0, $\overline{\text{BGH}}$).

ESD SENSITIVITY

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADSP-218xN features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

Interrupts and Flags

Table 16. Interrupts and Flags

Parameter		Min	Max	Unit
Timing Requirements:				
t_{IFS}	$\overline{IRQx}$, FI, or PFx Setup before CLKOUT Low[1, 2, 3, 4]	$0.25t_{CK} + 10$		ns
t_{IFH}	$\overline{IRQx}$, FI, or PFx Hold after CLKOUT High[1, 2, 3, 4]	$0.25t_{CK}$		ns
Switching Characteristics:				
t_{FOH}	Flag Output Hold after CLKOUT Low[5]	$0.5t_{CK} - 5$		ns
t_{FOD}	Flag Output Delay from CLKOUT Low[5]		$0.5t_{CK} + 4$	ns

[1] If $\overline{IRQx}$ and FI inputs meet t_{IFS} and t_{IFH} setup/hold requirements, they will be recognized during the current clock cycle; otherwise the signals will be recognized on the following cycle. (Refer to "Interrupt Controller Operation" in the *Program Control* chapter of the *ADSP-218x DSP Hardware Reference* for further information on interrupt servicing.)

[2] Edge-sensitive interrupts require pulse widths greater than 10 ns; level-sensitive interrupts must be held low until serviced.

[3] $\overline{IRQx}$ = $\overline{IRQ0}$, $\overline{IRQ1}$, $\overline{IRQ2}$, $\overline{IRQL0}$, $\overline{IRQL1}$, $\overline{IRQLE}$.

[4] PFx = PF0, PF1, PF2, PF3, PF4, PF5, PF6, PF7.

[5] Flag Outputs = PFx, FL0, FL1, FL2, FO.

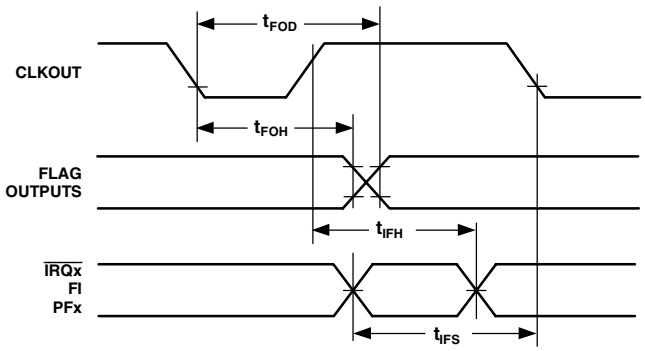

Figure 27. Interrupts and Flags

Bus Request–Bus Grant

Table 17. Bus Request–Bus Grant

Parameter		Min	Max	Unit
Timing Requirements:				
t_{BH}	$\overline{BR}$ Hold after CLKOUT High[1]	$0.25t_{CK} + 2$		ns
t_{BS}	$\overline{BR}$ Setup before CLKOUT Low[1]	$0.25t_{CK} + 8$		ns
Switching Characteristics:				
t_{SD}	CLKOUT High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable[2]		$0.25t_{CK} + 8$	ns
t_{SDB}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable to $\overline{BG}$ Low	0		ns
t_{SE}	$\overline{BG}$ High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable	0		ns
t_{SEC}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable to CLKOUT High	$0.25t_{CK} - 3$		ns
t_{SDBH}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable to $\overline{BGH}$ Low[3]	0		ns
t_{SEH}	$\overline{BGH}$ High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable[3]	0		ns

[1] $\overline{BR}$ is an asynchronous signal. If $\overline{BR}$ meets the setup/hold requirements, it will be recognized during the current clock cycle; otherwise the signal will be recognized on the following cycle. Refer to the *ADSP-2100 Family User's Manual* for $\overline{BR}$/BG cycle relationships.

[2] $\overline{xMS}$ = $\overline{PMS}$, $\overline{DMS}$, $\overline{CMS}$, $\overline{IOMS}$, $\overline{BMS}$.

[3] $\overline{BGH}$ is asserted when the bus is granted and the processor or BDMA requires control of the bus to continue.

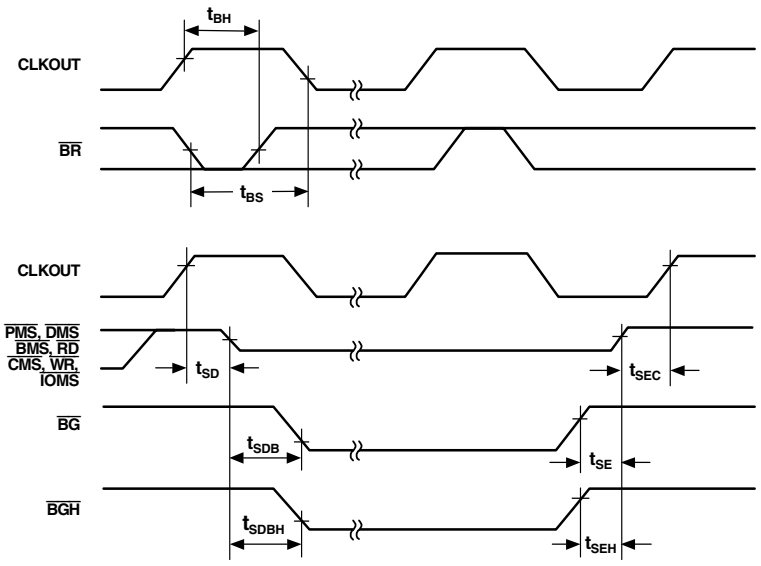

Figure 28. Bus Request–Bus Grant

Serial Ports

Table 20. Serial Ports

Parameter		Min	Max	Unit
Timing Requirements:				
t_{SCK}	SCLK Period	30		ns
t_{SCS}	DR/TFS/RFS Setup Before SCLK Low	4		ns
t_{SCH}	DR/TFS/RFS Hold After SCLK Low	7		ns
t_{SCP}	SCLKIN Width	12		ns
Switching Characteristics:				
t_{CC}	CLKOUT High to SCLKOUT	$0.25t_{CK}$	$0.25t_{CK} + 6$	ns
t_{SCDE}	SCLK High to DT Enable	0		ns
t_{SCDV}	SCLK High to DT Valid		7	ns
t_{RH}	TFS/RFS_{OUT} Hold after SCLK High	0		ns
t_{RD}	TFS/RFS_{OUT} Delay from SCLK High		7	ns
t_{SCDH}	DT Hold after SCLK High	0		ns
t_{TDE}	TFS (Alt) to DT Enable	0		ns
t_{TDV}	TFS (Alt) to DT Valid		7	ns
t_{SCDD}	SCLK High to DT Disable		7	ns
t_{RDV}	RFS (Multichannel, Frame Delay Zero) to DT Valid		7	ns

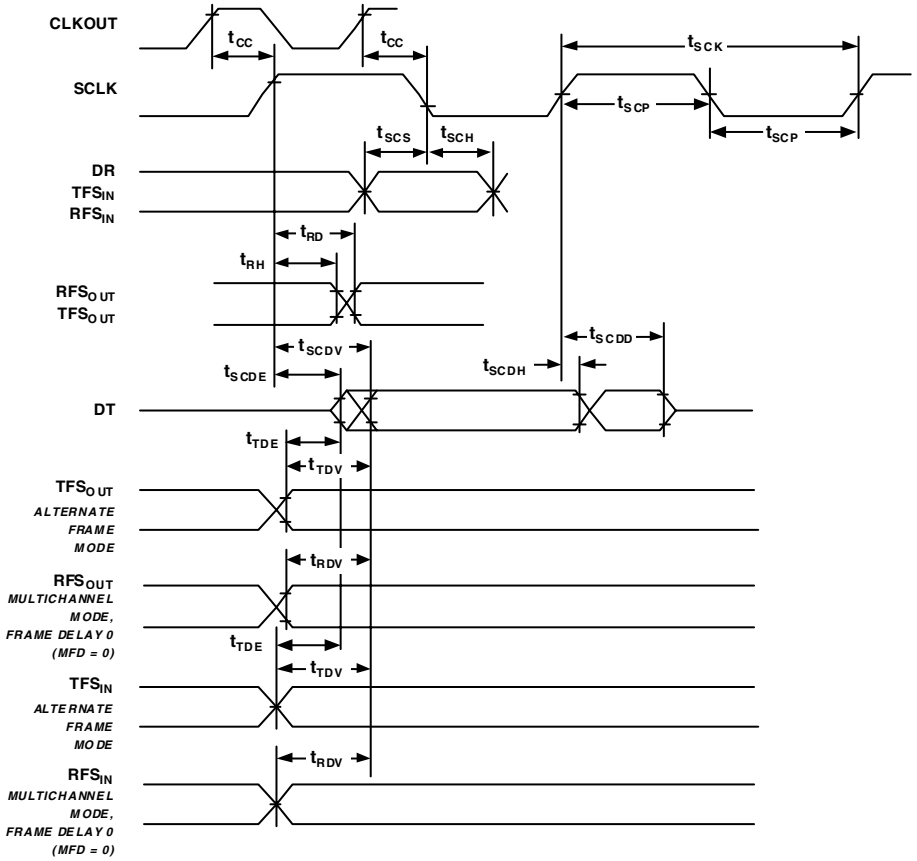

Figure 31. Serial Ports

IDMA Address Latch

Table 21. IDMA Address Latch

Parameter		Min	Max	Unit
Timing Requirements:				
t_{IALP}	Duration of Address Latch[1, 2]	10		ns
t_{IASU}	IAD15–0 Address Setup Before Address Latch End[2]	5		ns
t_{IAH}	IAD15–0 Address Hold After Address Latch End[2]	3		ns
t_{IKA}	$\overline{IACK}$ Low before Start of Address Latch[2, 3]	0		ns
t_{IALS}	Start of Write or Read After Address Latch End[2, 3]	3		ns
t_{IALD}	Address Latch Start After Address Latch End[1, 2]	2		ns

[1] Start of Address Latch = $\overline{IS}$ Low and IAL High.
[2] End of Address Latch = $\overline{IS}$ High or IAL Low.
[3] Start of Write or Read = $\overline{IS}$ Low and $\overline{IWR}$ Low or $\overline{IRD}$ Low.

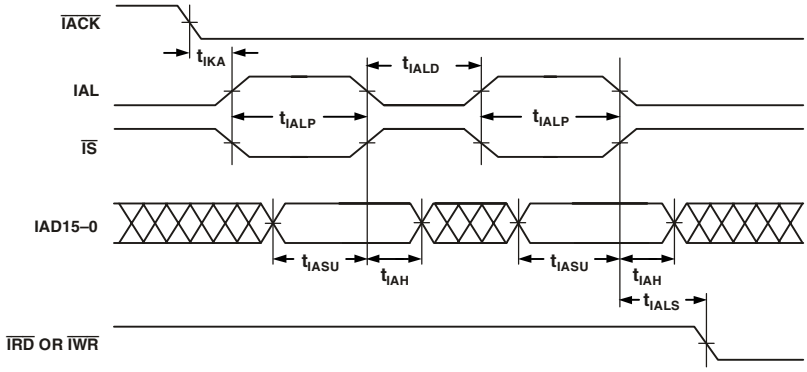

Figure 32. IDMA Address Latch

IDMA Read, Short Read Cycle in Short Read Only Mode

Table 26. IDMA Read, Short Read Cycle in Short Read Only Mode

Parameter[1]		Min	Max	Unit
Timing Requirements:				
t_{IKR}	$\overline{IACK}$ Low Before Start of Read[2]	0		ns
t_{IRP}	Duration of Read[3]	10		ns
Switching Characteristics:				
t_{IKHR}	$\overline{IACK}$ High After Start of Read[2]		10	ns
t_{IKDH}	IAD15–0 Previous Data Hold After End of Read[3]	0		ns
t_{IKDD}	IAD15–0 Previous Data Disabled After End of Read[3]		10	ns
t_{IRDE}	IAD15–0 Previous Data Enabled After Start of Read	0		ns
t_{IRDV}	IAD15–0 Previous Data Valid After Start of Read		10	ns

[1] Short Read Only is enabled by setting Bit 14 of the IDMA overlay Register to 1 (0x3FE7). Short Read Only can be enabled by the processor core writing to the register or by an external host writing to the register. Disabled by default.
[2] Start of Read = $\overline{IS}$ Low and $\overline{IRD}$ Low. Previous data remains until end of read.
[3] End of Read = $\overline{IS}$ High or $\overline{IRD}$ High.

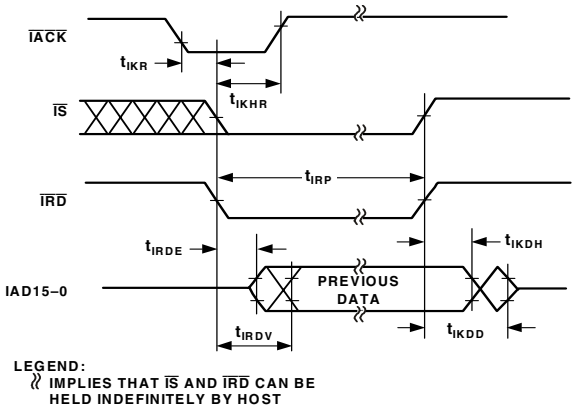

Figure 37. IDMA Read, Short Read Cycle in Short Read Only Mode

Table 27. LQFP Package Pinout

Pin No.	Pin Name
1	A4/**IAD3**
2	A5/**IAD4**
3	GND
4	A6/**IAD5**
5	A7/**IAD6**
6	A8/**IAD7**
7	A9/**IAD8**
8	A10/**IAD9**
9	A11/**IAD10**
10	A12/**IAD11**
11	A13/**IAD12**
12	GND
13	CLKIN
14	XTAL
15	V_{DDEXT}
16	CLKOUT
17	GND
18	V_{DDINT}
19	$\overline{WR}$
20	$\overline{RD}$
21	$\overline{BMS}$
22	$\overline{DMS}$
23	$\overline{PMS}$
24	$\overline{IOMS}$
25	$\overline{CMS}$
26	$\overline{IRQE}$ + PF4
27	$\overline{IRQL0}$ + PF5
28	GND
29	$\overline{IRQL1}$ + PF6
30	$\overline{IRQ2}$ + PF7
31	DT0
32	TFS0
33	RFS0
34	DR0
35	SCLK0
36	V_{DDEXT}
37	DT1/FO
38	TFS1/$\overline{IRQ1}$
39	RFS1/$\overline{IRQ0}$
40	DR1/FI
41	GND
42	SCLK1
43	$\overline{ERESET}$
44	$\overline{RESET}$
45	$\overline{EMS}$
46	EE
47	ECLK
48	ELOUT
49	ELIN
50	$\overline{EINT}$

Table 27. LQFP Package Pinout (Continued)

Pin No.	Pin Name
51	$\overline{EBR}$
52	$\overline{BR}$
53	$\overline{EBG}$
54	$\overline{BG}$
55	D0/**IAD13**
56	D1/**IAD14**
57	D2/**IAD15**
58	D3/$\overline{\textbf{IACK}}$
59	V_{DDINT}
60	GND
61	D4/$\overline{\textbf{IS}}$
62	D5/**IAL**
63	D6/$\overline{\textbf{IRD}}$
64	D7/$\overline{\textbf{IWR}}$
65	D8
66	GND
67	V_{DDEXT}
68	D9
69	D10
70	D11
71	GND
72	D12
73	D13
74	D14
75	D15
76	D16
77	D17
78	D18
79	D19
80	GND
81	D20
82	D21
83	D22
84	D23
85	FL2
86	FL1
87	FL0
88	PF3 [Mode D]
89	PF2 [Mode C]
90	V_{DDEXT}
91	$\overline{PWD}$
92	GND
93	PF1 [Mode B]
94	PF0 [Mode A]
95	$\overline{BGH}$
96	PWDACK
97	A0
98	A1/**IAD0**
99	A2/**IAD1**
100	A3/**IAD2**

Table 28. BGA Package Pinout

Ball No.	Pin Name
A01	A2/**IAD1**
A02	A1/**IAD0**
A03	GND
A04	A0
A05	NC
A06	GND
A07	NC
A08	NC
A09	NC
A10	D22
A11	GND
A12	GND
B01	A4/**IAD3**
B02	A3/**IAD2**
B03	GND
B04	NC
B05	NC
B06	GND
B07	V_{DDEXT}
B08	D23
B09	D20
B10	D18
B11	D17
B12	D16
C01	PWDACK
C02	A6/**IAD5**
C03	$\overline{RD}$
C04	A5/**IAD4**
C05	A7/**IAD6**
C06	$\overline{PWD}$
C07	V_{DDEXT}
C08	D21
C09	D19
C10	D15
C11	NC
C12	D14
D01	NC
D02	$\overline{WR}$
D03	NC
D04	$\overline{BGH}$
D05	A9/**IAD8**
D06	PF1 [MODE B]
D07	PF2 [MODE C]
D08	NC
D09	D13
D10	D12
D11	NC
D12	GND
E01	V_{DDEXT}

Table 28. BGA Package Pinout (Continued)

Ball No.	Pin Name
E02	V_{DDEXT}
E03	A8/**IAD7**
E04	FL0
E05	PF0 [MODE A]
E06	FL2
E07	PF3 [MODE D]
E08	GND
E09	GND
E10	V_{DDEXT}
E11	GND
E12	D10
F01	A13/**IAD12**
F02	NC
F03	A12/**IAD11**
F04	A11/**IAD10**
F05	FL1
F06	NC
F07	NC
F08	D7/$\overline{\textbf{IWR}}$
F09	D11
F10	D8
F11	NC
F12	D9
G01	XTAL
G02	NC
G03	GND
G04	A10/**IAD9**
G05	NC
G06	NC
G07	NC
G08	D6/$\overline{\textbf{IRD}}$
G09	D5/**IAL**
G10	NC
G11	NC
G12	D4/$\overline{\textbf{IS}}$
H01	CLKIN
H02	GND
H03	GND
H04	GND
H05	V_{DDINT}
H06	DT0
H07	TFS0
H08	D2/**IAD15**
H09	D3/$\overline{\textbf{IACK}}$
H10	GND
H11	NC
H12	GND
J01	CLKOUT
J02	V_{DDINT}

OUTLINE DIMENSIONS

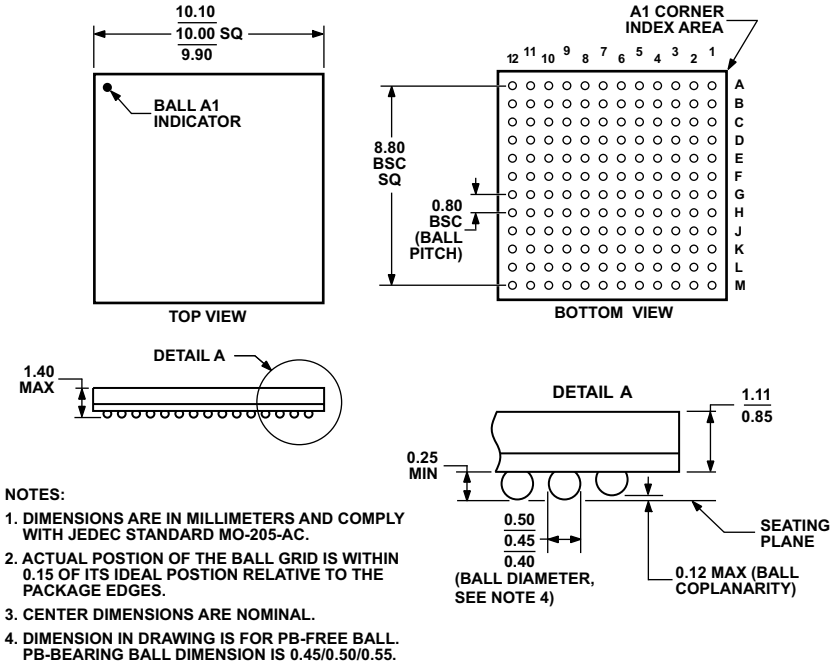

Figure 40. 144-Ball BGA [CSP_BGA] (BC-144-6)

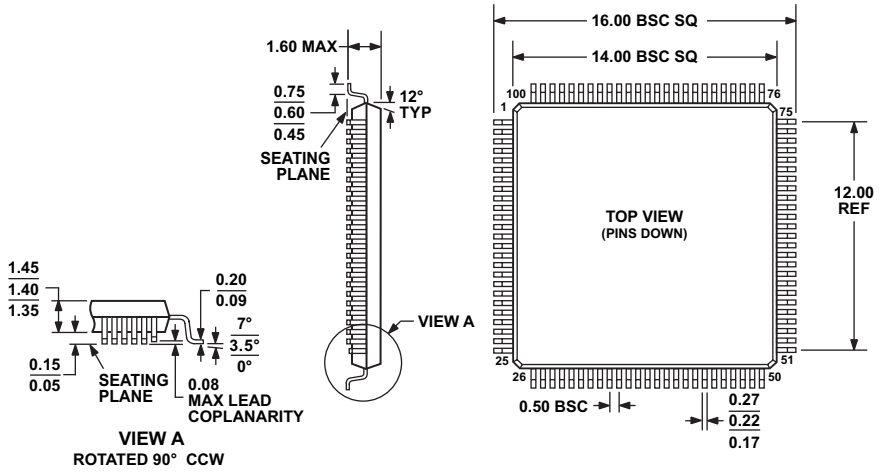

Figure 41. 100-Lead Low Profile Quad Flat Package [LQFP] (ST-100-1)